



SBW

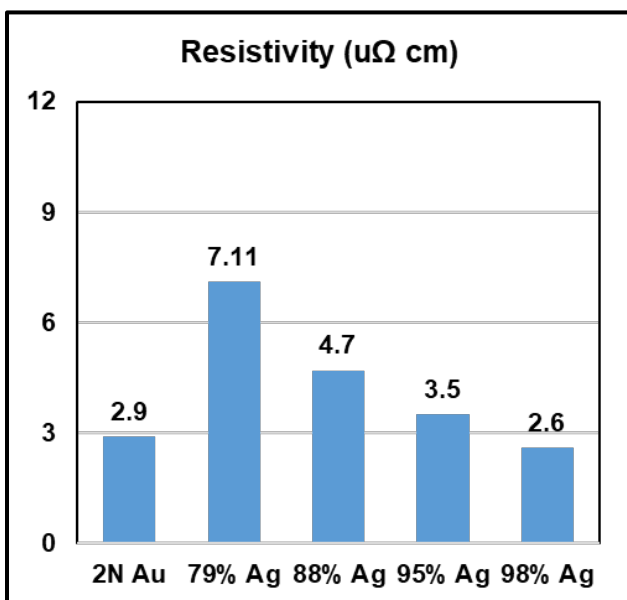
Silver Alloy Bonding Wire

Silver alloy wire is applied in die to die package instead of PCW. It is no limitation for bond pad structure and Al pad thickness same as Au wire. It can be applied for the fine pitch device.

LT Metal Ag wire Lineup

PKG	Purity	Type	Feature
IC Package (Logic & Memory)	88%	HS-E, HS-FG	Original type
	95%	HS-ES5, HS-FG4	Lower cost than Ag88%
	97.5%	HS-ES8	High Conductivity
LED	79%	HS-LS	High Reliability

Resistivity



Hardness

